## **BAS16WS-AH**

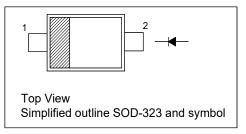
# Silicon Epitaxial Planar Switching Diode

#### **Features**

- AEC-Q101 Qualified
- · Fast switching speed
- Ultra-small surface mount package
- For general purpose switching applications
- Halogen and Antimony Free(HAF), RoHS compliant

#### **PINNING**

PIN	DESCRIPTION
1	Cathode
2	Anode



## Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit	
Reverse Voltage	V <sub>R</sub>	100	V	
Peak Reverse Voltage	$V_{RM}$	100	V	
Forward Current (Continuous)		l <sub>F</sub>	300	mA
Non-repetitive Peak Forward Surge Current	at t = 1 s at t = 1 ms at t = 1 µs	Ігѕм	0.5 1 2	А
Power Dissipation		P <sub>tot</sub>	200	mW
Junction Temperature		Tj	150	°C
Storage Temperature Range		T <sub>stg</sub>	- 65 to + 150	°C

#### **Thermal Characteristics**

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient 1)	Reja	625	°C/W

<sup>&</sup>lt;sup>1)</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



# **BAS16WS-AH**

## Characteristics at $T_a = 25$ °C

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I <sub>R</sub> = 100 µA		100	-	V
Forward Voltage at $I_F = 1$ mA at $I_F = 10$ mA at $I_F = 50$ mA at $I_F = 150$ mA	VF	- - - -	0.715 0.855 1 1.25	V
Reverse Leakage Current at $V_R$ = 100 V at $V_R$ = 25 V, $T_j$ = 150 °C at $V_R$ = 75 V, $T_j$ = 150 °C	I <sub>R</sub>	- - -	1 30 50	μA
Diode Capacitance at $V_R = 0 V$ , $f = 1 MHz$	C <sub>tot</sub>	-	1.5	pF
Reverse Recovery Time at $I_F = 10$ mA, $V_R = 6$ V, $R_L = 100$ $\Omega$ , $I_{rr} = 0.1 \times I_R$	t <sub>rr</sub>	-	4	ns



#### **Electrical Characteristics Curves**

Fig 1. Power Dissipation vs. Temperature

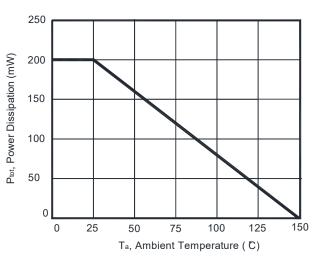


Fig 2. Total Capacitance vs. Reverse Voltage

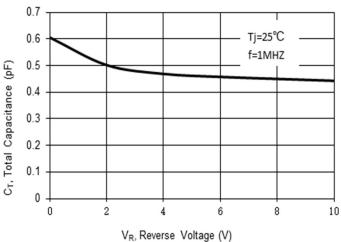


Fig 3. Reverse Current vs. Reverse Voltage

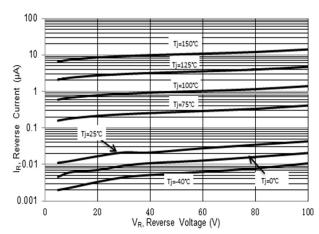
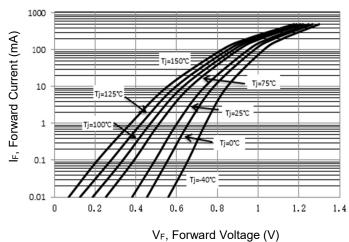


Fig 4. Forward Characteristics

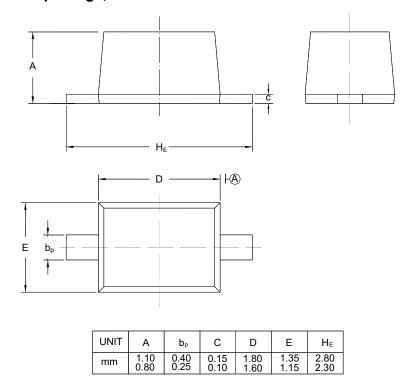




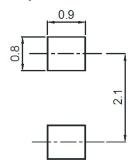
#### **PACKAGE OUTLINE**

## Plastic surface mounted package; 2 leads

**SOD-323** 



## **Recommended Soldering Footprint**



#### **Packing information**

Package Ta	Tape Width	Pitch		Reel Size		Dor Dool Doolsing Quantity
	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity
SOD-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

## **Marking information**

" W2 " = Part No.

" III " = Cathode line

"•" = HAF (Halogen and Antimony Free)

#### Font type: Arial

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